

Special Issue

Reliability and Engineering Applications

Message from the Guest Editors

Reliable processes are critical in various fields including chemical, mechanical, electrical, material, and biomedical engineering with various scales from nano to macro. This Special Issue aims to provide insights for researchers to discuss recent advanced reliable processes and techniques, and applications to address many challenging engineering problems. Unique and novel manufacturing, modeling, and numerical methods of any industrial applications are of special interest.

Guest Editors

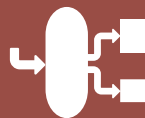
Dr. Hongyun So

Dr. Jong-Won Park

Dr. Sunghan Kim

Deadline for manuscript submissions

closed (25 March 2023)



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Processes
Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland
Tel: +41 61 683 77 34
processes@mdpi.com

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Editor-in-Chief

Prof. Dr. Giancarlo Cravotto

Department of Drug Science and Technology, University of Turin, Via P. Giuria 9, 10125 Turin, Italy

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